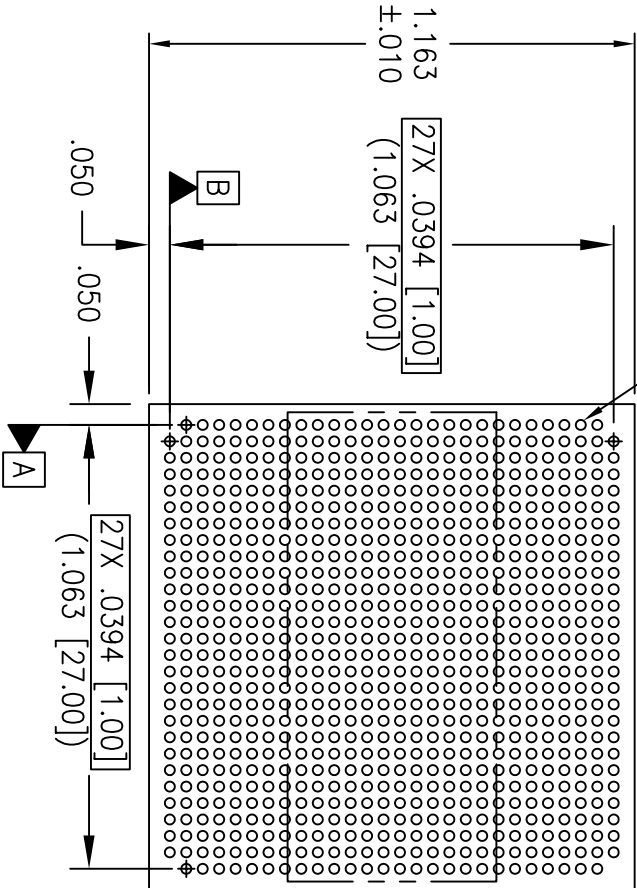


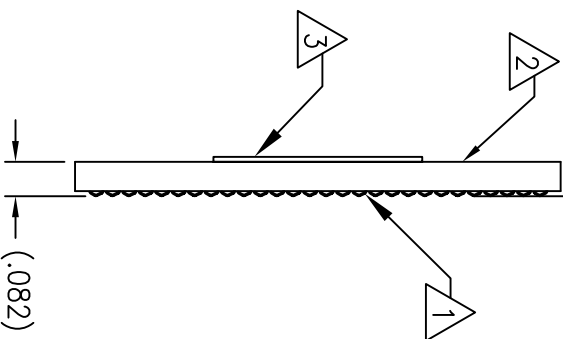
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REV	DESCRIPTION	EGN	DATE	RELEASE
1	SALES RELEASE			

780X CONTACTS
 Φ .003 (M) A B



TOP VIEW



RS VIEW

NOTES:

1. CONTACT MATERIAL: BERYLLIUM COPPER.
CONTACT PLATING: HARD GOLD OVER NICKEL.
2. INSULATOR MATERIAL: FR4
3. KAPTON TAPE FOR PICK AND PLACE.
4. REFER TO ISI HiLo APPLICATION GUIDELINES FOR LAND PATTERN, STENCIL DESIGN AND KEEP OUT ZONE RECOMMENDATIONS.

CONTRACT NO.		DRAWN BY		DATE		TITLE	
UNLESS OTHERWISE SPECIFIED:		DESIGNER		DATE		INTERCONNECT SYSTEMS INC.	
DIMENSIONS ARE IN INCHES		CHECKER		DATE		708 VIA ALONDRA, CAMARILLO, CA 93012	
TOLERANCES: ± 1/64		DATE		DATE		HILO SOCKET	
ANGLES: ± .010		DATE		DATE		28 X 28, 780 CONTACTS	
FRACTURES: .XXX		DATE		DATE		1mm PITCH	
DECIMALS: .XXXX		DATE		DATE		SCALE: DRAWING NO.	
.XXXX ±.0005		DATE		DATE		N/A HLS-280780-B-10	
		PROCESS ENG.		DATE		FINISHED ASST: HLS-280780-B-10	
		DATE		DATE		SHEET 1 OF 1	

ASIZE 4 3 2 1